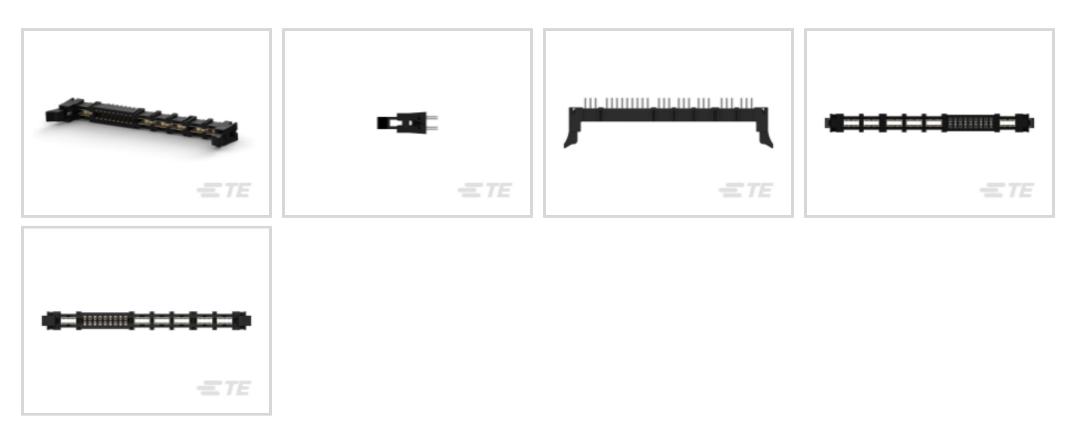
# 1651826-1 - ACTIVE

#### MINI CROWN EDGE | CROWN EDGE

TE Internal #: 1651826-1 Board-to-Board Card Edge Power Connector, 30 Position, 2.5 mm [. 098 in] Centerline, Power & Signal, 12 Power Positions, CROWN EDGE

#### View on TE.com >

#### Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: Board-to-Board

Number of Positions: 30

Centerline (Pitch): 2.5 mm [.098 in]

Contact Current Rating (Max): 25 A

Circuit Application: Power & Signal

## Features



#### **Product Type Features**

| Connector & Contact Terminates To | Printed Circuit Board |
|-----------------------------------|-----------------------|
| Connector Mates With              | Mates with Plug       |
| Connector & Housing Type          | Receptacle            |
| Connector System                  | Board-to-Board        |
| Configuration Features            |                       |
| PCB Mount Orientation             | Vertical              |
| Number of Positions               | 30                    |
| Number of Power Positions         | 12                    |
| Number of Signal Positions        | 18                    |
| Number of Dual Positions          | 6                     |
| Electrical Characteristics        |                       |
| Operating Voltage                 | 250 V                 |
| Body Features                     |                       |
| Primary Product Color             | Black                 |

**C** For support call+1 800 522 6752

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### **Contact Features**

| PCB Contact Termination Area Plating Material Finish    | Matte                          |
|---|--------------------------------|
| Contact Mating Area Plating Material Thickness          | .76 μm[29.92 μin]              |
| PCB Contact Termination Area Plating Material Thickness | 3.05 μm[120 μin]               |
| Contact Layout  | Staggered                      |
| Contact Base Material                                   | Copper Alloy                   |
| PCB Contact Termination Area Plating Material           | Tin                            |
| Contact Type  | Socket                         |
| Contact Current Rating (Max)                            | 25 A                           |
| Contact Mating Area Plating Material                    | Gold (Au)                      |
| Termination Features                                    |                                |
| Termination Post & Tail Length                          | 4.5 mm[.177 in]                |
| Termination Method to PCB                               | Through Hole - Solder          |
| Mechanical Attachment                                   |                                |
| Connector Mounting Type                                 | Board Mount                    |
| Mating Retention Type                                   | Latch                          |
| PCB Mount Retention                                     | Without                        |
| Mating Retention  | With                           |
| Mating Alignment Type                                   | Blindmate, Keyed               |
| Mating Alignment  | With                           |
| PCB Mount Alignment                                     | With                           |
| Housing Features  |                                |
| Housing Material  | Thermoplastic                  |
| Centerline (Pitch)                                      | 2.5 mm[.098 in]                |
| Dimensions  |                                |
| Card Slot Depth   | 6 mm[.236 in]                  |
| Row-to-Row Spacing                                      | 3.33 mm                        |
| Accepts Card Thickness                                  | 1.57 mm[.062 in]               |
| Accepts Card Width                                      | 93.34 mm[3.67 in]              |
| PCB Thickness (Recommended)                             | 1.57 – 3.18 mm[.062 – .125 in] |
| Connector Height  | 20 mm[.787 in]                 |
| Power Contact Centerline                                | 9.7 mm[.381 in]                |
|   |                                |

Board-to-Board Card Edge Power Connector, 30 Position, 2.5 mm [.098 in] Centerline, Power & Signal, 12 Power Positions, CROWN EDGE



| Usage Conditions  |                            |
|---|----------------------------|
| Operating Temperature Range   | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application   |                            |
| Circuit Application   | Power & Signal             |
| Industry Standards  |                            |
| Compatible With Agency/Standards Products   | CSA, UL                    |
| UL Flammability Rating  | UL 94V-0                   |
| Compatible With Approved Standards Products   | CSA 1935071, UL 1977       |
| Packaging Features  |                            |
| Packaging Quantity  | 32                         |
| Packaging Method  | Box & Tray, Tray           |
| Product Compliance<br>For compliance documentation, visit the product page on TE.com> |                            |
| EU RoHS Directive 2011/65/EU  | Compliant                  |
| EU ELV Directive 2000/53/EC   | Compliant                  |

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2025<br>(247)<br>Candidate List Declared Against: JAN 2025<br>(247)<br>Does not contain REACH SVHC |
|--|---|
| Halogen Content                        | Not Low Halogen - contains Br or Cl > 900<br>ppm.   |
| Solder Process Capability              | Wave solder capable to 265°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

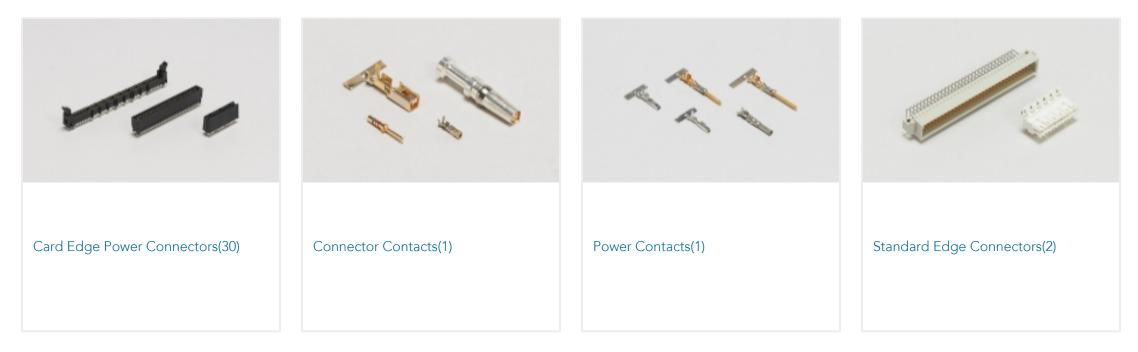
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**Compatible Parts** 



## Also in the Series | CROWN EDGE



# Customers Also Bought





### Documents

Product Drawings 283-0172-01303=CONN,SKT,CRNEDG

English

**CAD** Files

Board-to-Board Card Edge Power Connector, 30 Position, 2.5 mm [.098 in] Centerline, Power & Signal, 12 Power Positions, CROWN EDGE



#### 3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_1651826-1\_C.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1651826-1\_C.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1651826-1\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Datasheets & Catalog Pages POWER\_CONNECTORS\_CATALOG\_SEC04\_VRM

English

Product Specifications Application Specification

English